Unit: mm

# **Preliminary**

TOSHIBA Multi Chip Discrete Device

# HN7G01FU

Power Management Switch Application
Driver Circuit Application
Interface Circuit Application

Q1 (transistor): 2SA1955 equivalent
Q2 (MOS-FET): 2SK1830 equivalent

### Q1 (transistor) Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	$V_{CBO}$	-15	V
Collector-emitter voltage	V <sub>CEO</sub>	-12	V
Emitter-base voltage	V <sub>EBO</sub>	-5	V
Collector current	IC	-400	mA
Base current	Ι <sub>Β</sub>	-50	mA

#### Q2 (MOS-FET) Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DS}$	20	V
Gate-source voltage	$V_{GSS}$	10	V
Drain current	I <sub>D</sub>	50	mA

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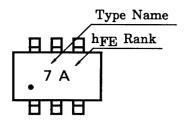
Weight: 6.8 mg (typ.)

#### Q1, Q2 Common Ratings (Ta = 25°C)

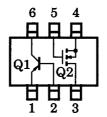
Characteristics	Symbol	Rating	Unit
Power dissipation	P <sub>C</sub> (Note 1)	200	mW
Junction temperature	Tj	125	°C
Storage temperature range	T <sub>stg</sub>	<b>−55~150</b>	°C

Note 1: Total rating

#### Marking



### Pin Assignment (top view)



## Q1 (transistor) Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = -15 \text{ V}, I_E = 0$	_	_	-0.1	μΑ
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = -5 \text{ V}, I_C = 0$			-0.1	mA
DC current gain	h <sub>FE</sub> (Note 2)	$V_{CE} = -2 \text{ V}, I_{C} = -10 \text{ mA}$	300		1000	
Collector-emitter saturation voltage	V <sub>CE</sub> (sat) (1)	$I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$		-15	-30	mV
Conector-entitler saturation voltage	V <sub>CE</sub> (sat) (2)	$I_C = -200 \text{ mA}, I_B = -10 \text{ mA}$		-110	-250	111 V
Base-emitter saturation voltage	V <sub>BE (sat)</sub>	$I_C = -200 \text{ mA}, I_B = -10 \text{ mA}$	_	-0.87	-1.2	V

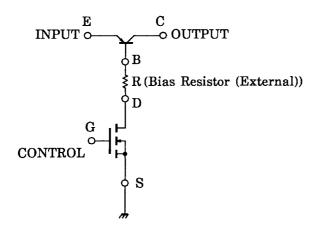
Note 2: h<sub>FE</sub> classification A: 300~600, B: 500~1000

### Q2 (MOS-FET) Electrical Characteristics (Ta = 25°C)

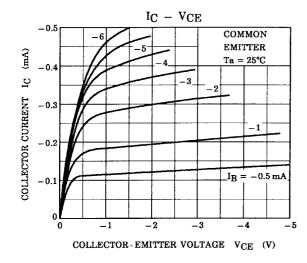
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS} = 10 \text{ V}, V_{DS} = 0$	_	_	1	μΑ
Drain-source breakdown voltage	V (BR) DSS	$I_D = 100 \ \mu A, \ V_{GS} = 0$	20	_	_	V
Drain current	I <sub>DSS</sub>	$V_{DS} = 20 V, V_{GS} = 0$	_	_	1	μΑ
Gate threshold voltage	$V_{th}$	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.5	_	1.5	V
Forward transfer admittance	Y <sub>fs</sub>	$V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$	20	_	_	mS
Drain-source ON resistance	R <sub>DS (ON)</sub>	$I_D = 10$ mA, $V_{GS} = 2.5$ V	_	20	40	Ω

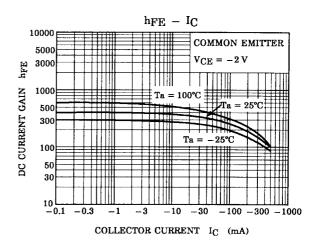
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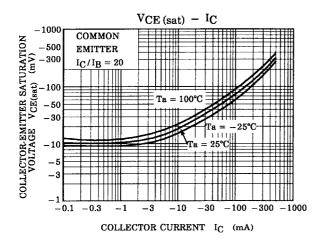
## **Application Example (power management switch)**

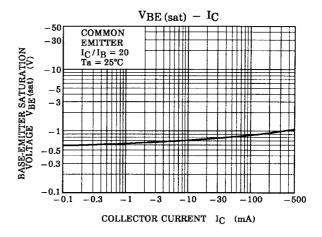


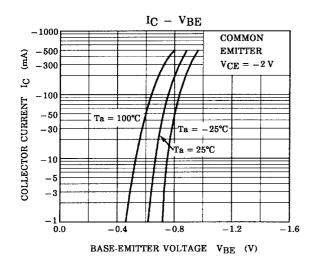
#### **Transistor**



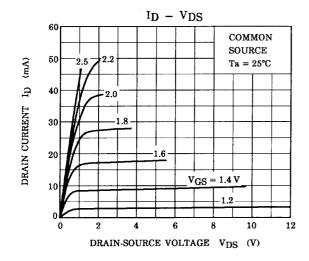


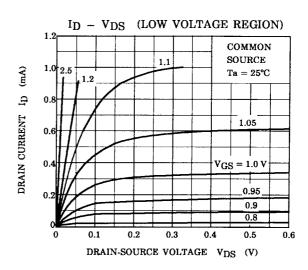


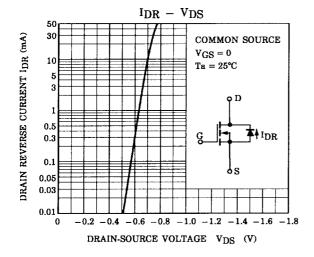


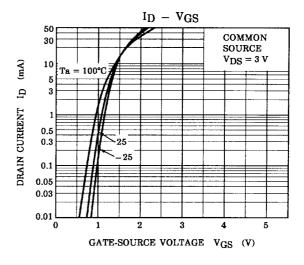


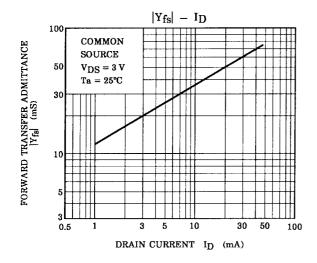
#### **MOS-FET**

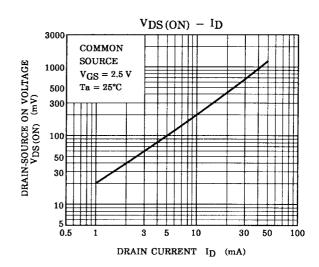












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